

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S2 series

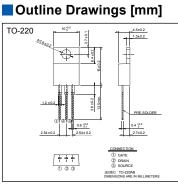
N-Channel enhancement mode power MOSFET

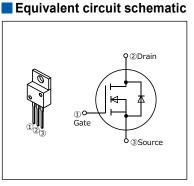
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at T_{vi}=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Durain Courses Vielte and	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current		38.1	А	T _{vj} =25°C Note*1,2
	I _D	24.1	А	T _{vj} =100°C Note*1,2
Pulsed Drain Current	I DP	117	А	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	IAS	4.4	А	Note *3
Non-Repetitive Maximum Avalanche Energy	Eas	930	mJ	Note *4
Maximum Drain-Source dV/dt	dV₀s/dt	50	V/ns	<i>V</i> _{DS} ≤ 600V
Continuous	1	38.1	А	T _{vj} =25°C Note*1,2
Diode Forward Current	Isd	24.1	А	T _{vj} =100°C Note*1,2
Pulsed Diode Forward Current	ISDP	117	А	Note *2
Peak Diode Recovery dV/dt	dV/dt	15	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
Maximum Bower Discinction	PD	2.02	W	<i>T</i> _a =25°C
Maximum Power Dissipation	PD	210	vv	<i>T</i> c=25°C
Operating and Storage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.65

Note *1: Imited by maximum channel temperature. Note *3: T_{ch}≤150°C, See Fig.1 and Fig.2 Note *4: Starting T_{oh}=25°C, I_As=2.7A, L=234mH, V_{DD}=60V, R_G=50Ω, See Fig.1 and Fig.2 E_{AS} limited by maximum channel temperature and avalanche current. Note *5: I_{SD}≤29.2A, -di/dt≤100A/µs, V_{DS peak}≤ 600V, T_{ch}≤150°C. Note *6: I_{SD}≤29.2A, dV/dt≤15V/ns, V_{DS peak}≤ 600V, T_{ch}≤150°C.

Electrical Characteristics at T_{vi}=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V₀s=0V /₀=250µA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I₀=1.54mA		3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	Ioss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	<i>T</i> _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{DS} =0V V _{GS} = ± 30V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V I₀=14.6A		-	0.092	0.099	Ω
Gate resistance	RG	f=1MHz, open drain		-	7.8	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	V _{DS} =25V I _D =14.6A	9.5	19	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	1630	-	
Output Capacitance	Coss	V _{GS} =0V	-	54	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	7.0	-	
Effective output capacitance, energy related (Note *7)	Co(er)	V _{DS} =0400V V _{GS} =0V	-	124	-	pF
Effective output capacitance, time related (Note *8)	Co(tr)	V₀s=0400V V₀s=0V /₀=constant	-	489	-	
t _{d(on)}		-	29	-		
Turn-On Time	tr	/ _D =14.6A,	-	87	-	- ns
Turn-Off Time $\frac{t_{d(off)}}{t_{f}}$	t _{d(off)}	$R_{\rm G}=15\Omega$ See Fig.3 and Fig.4	-	121	-	
	<i>t</i> r		-	24	-	
Total Gate Charge	QG		-	65	-	nC
Gate-Source Charge	Q _{GS}	V_{DD} =400V, V_{GS} =10V	-	28	-	
Gate-Drain Charge	QGD	— /₀=29.2A See Fig.5	-	25	-	
Drain-Source crossover Charge	Qsw		-	19	-	

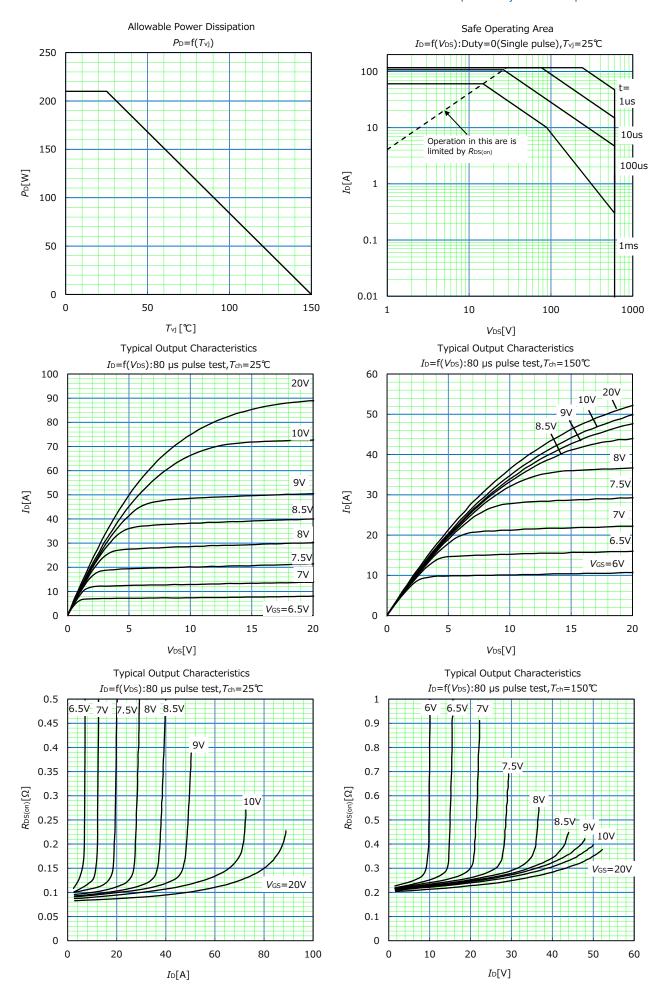
Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *8 : $C_{0(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

Reverse Diode

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Diode Forward On-Voltage	V _{SD}	I _{SD} =29.2A, V _{GS} =0V T _{ch} =25°C	-	0.95	1.35	V
Reverse Recovery Time	trr	- V₀₀=400V, /₅₀=29.2A -di/dt=100A/µs T₅h=25°C See Fig.6 and Fig.7	-	360	-	ns
Reverse Recovery Charge	Qrr		-	6.0	-	μC
Peak Reverse Recovery Current	I _{rp}		-	32	-	А

Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	0.60	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	62	°C/W



Drain-Source On-state Resistance

 $R_{DS(on)}=f(T_{ch}):I_{D}=14.6A, V_{GS}=10V$

max

typ.

Tch[℃]

Typical Transfer Characteristic

ID=f(VGs) : 80µs pulse test, VDS=25V

60

100

*T*ch=25℃

8

*T*ch=25℃

1

10

1.5

140

20

150℃

4

 $V_{GS}[V]$ Typical Forward Characteristics of Reverse Diode

 $I_{SD}=f(V_{SD}):80 \ \mu s \ pulse \ test$

6

-60

100

10

1

0.1

100

10

1

0

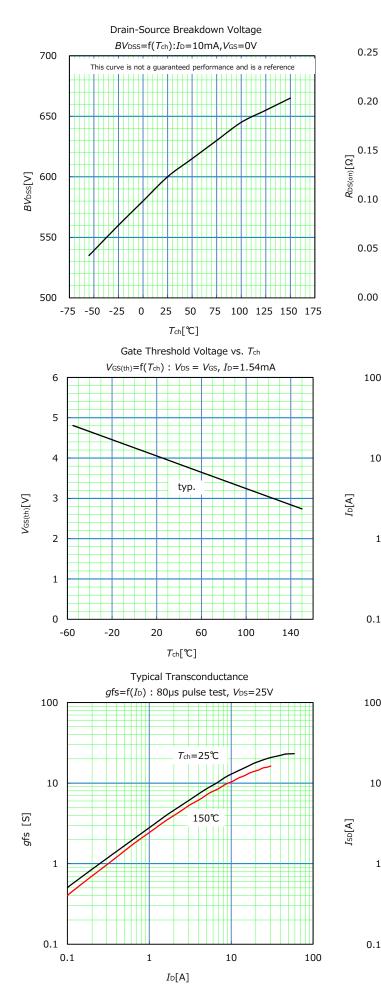
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150℃

0.5

 $V_{SD}[V]$

-20

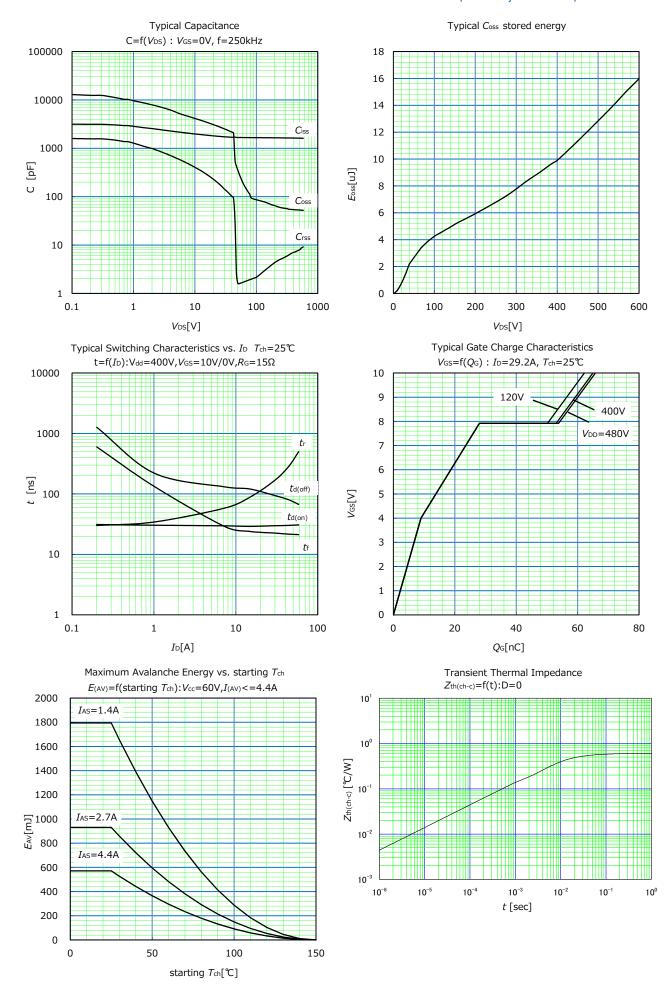


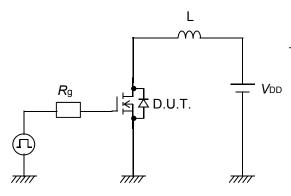


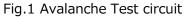
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0.1

0







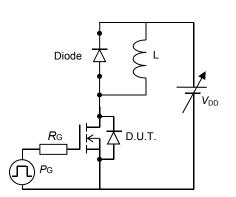


Fig.3 Switching Test circuit

+10V -15V /AV 0 /AV /DS /D

Fig.2 Operating waveforms of Avalanche Test

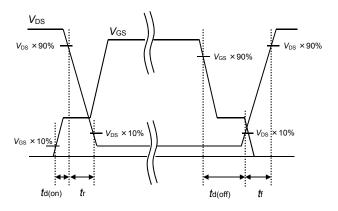


Fig.4 Operating waveform of Switching Test

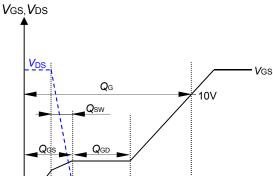
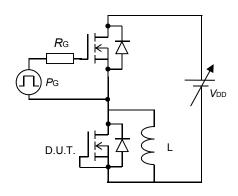


Fig.5 Operating waveform of Gate charge Test

→ Qg



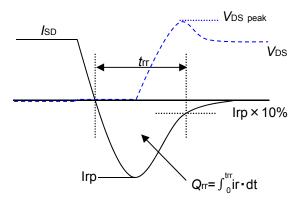
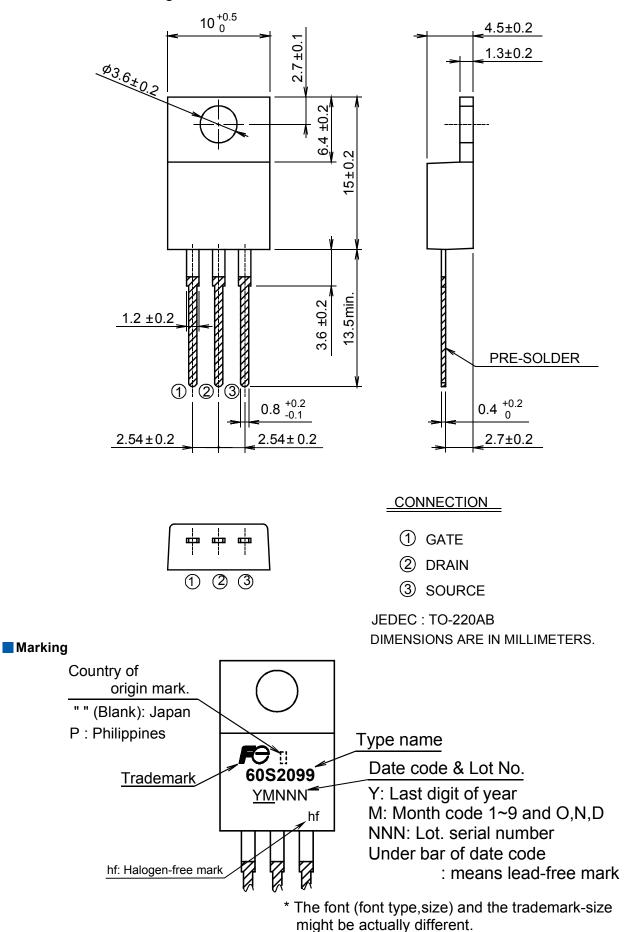


Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-220 Package



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